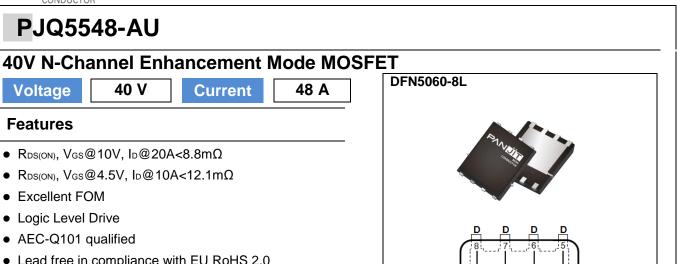
| ΡΛΝ | JIT       |
|-----|-----------|
|     | SEMI      |
|     | CONDUCTOR |

Voltage

**Features** 

 Excellent FOM • Logic Level Drive • AEC-Q101 qualified

## **PJQ5548-AU**



• Lead free in compliance with EU RoHS 2.0

40 V

• Rds(ON), Vgs@10V, Id@20A<8.8mΩ • Rds(ON), Vgs@4.5V, Id@10A<12.1mΩ

• Green molding compound as per IEC 61249 standard

Current

#### **Mechanical Data**

- Case : DFN5060-8L Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.08 grams

## Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

| PARAMETE  | SYMBOL               | LIMIT            | UNITS   |      |
|---|----------------------|------------------|---------|------|
| Drain-Source Voltage                              |                      | V <sub>DS</sub>  | 40      | V    |
| Gate-Source Voltage                               |                      | V <sub>GS</sub>  | ±20     | V    |
| Continuous Drain Current <sup>(Note 3)</sup>      | T <sub>C</sub> =25°C |                  | 48      |      |
|   | Tc=100°C             | I <sub>D</sub>   | 34      | A    |
| Pulsed Drain Current(Note 1)                      | T <sub>C</sub> =25°C | I <sub>DM</sub>  | 192     |      |
| Power Dissipation                                 | T <sub>C</sub> =25°C |                  | 36      |      |
|   | Tc=100°C             | PD               | 18      | W    |
| Continuous Drain Current <sup>(Note 4)</sup>      | T <sub>A</sub> =25°C |                  | 14.5    |      |
|   | T <sub>A</sub> =70°C | I <sub>D</sub>   | 12      | A    |
| Power Dissipation                                 | T <sub>A</sub> =25°C | D-               | 3.3     | W    |
|   | T <sub>A</sub> =70°C | PD               | 2.3     | VV   |
| Single Pulse Avalanche Energy <sup>(Note 5)</sup> |                      | Eas              | 42      | mJ   |
| Operating Junction and Storage Temperature Range  |                      | TJ,TSTG          | -55~175 | °C   |
| Thermal Resistance <sup>(Note 4)</sup>            | Junction to Case     | R <sub>θJC</sub> | 4.2     | °C/W |
|   | Junction to Ambient  | $R_{	heta JA}$   | 45      | 0/00 |

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#### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

| PARAMETER                        | SYMBOL              | TEST CONDITION   | MIN. | TYP. | MAX. | UNITS |
|----------------------------------|---------------------|--|------|------|------|-------|
| Static                           |                     |  |      |      |      |       |
| Drain-Source Breakdown Voltage   | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA   | 40   | -    | -    | Ň     |
| Gate Threshold Voltage           | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =50uA                                | 1.1  | 1.6  | 2.3  | V     |
| Drain-Source On-State Resistance | R <sub>DS(on)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =20A  | -    | 7    | 8.8  | mΩ    |
|                                  |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A   |      | 9.3  | 12.1 |       |
| Zero Gate Voltage Drain Current  | I <sub>DSS</sub>    | $V_{DS}$ =40V, $V_{GS}$ =0V  | -    | -    | 1    | uA    |
|                                  |                     | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V   | -    | -    | ±10  | uA    |
| Gate-Source Leakage Current      | I <sub>GSS</sub>    | V <sub>GS</sub> =±10V, V <sub>DS</sub> =0V   | -    | -    | ±1   |       |
| Dynamic <sup>(Note 6)</sup>      |                     |  |      |      |      |       |
| Total Gate Charge                | Qg                  | V <sub>DS</sub> =32V, I <sub>D</sub> =20A,<br>V <sub>GS</sub> =10V                     | -    | 13   | -    | nC    |
| Gate-Source Charge               | Qgs                 |  | -    | 3    | -    |       |
| Gate-Drain Charge                | Q <sub>gd</sub>     |  | -    | 2    | -    |       |
| Input Capacitance                | Ciss                | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,<br>f=1MHz                                   | -    | 778  | -    | pF    |
| Output Capacitance               | Coss                |  | -    | 180  | -    |       |
| Reverse Transfer Capacitance     | Crss                |  | -    | 25   | -    |       |
| Gate resistance                  | Rg                  | f=1MHz   | -    | 1.6  | -    | Ω     |
| Turn-On Delay Time               | td <sub>(on)</sub>  | V <sub>DS</sub> =32V, I <sub>D</sub> =20A,<br>V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω | -    | 7    | -    |       |
| Turn-On Rise Time                | tr                  |  | -    | 78   | -    | ns    |
| Turn-Off Delay Time              | td(off)             |  | -    | 26   | -    |       |
| Turn-Off Fall Time               | tf                  |  | -    | 56   | -    |       |
| Drain-Source Diode               |                     | ·  |      |      | •    |       |
| Diode Forward Current            | Is                  | T <sub>c</sub> =25°C   | -    | -    | 48   |       |
| Pulsed Diode Forward Current     | I <sub>SM</sub>     | 1C=20 C  | -    | -    | 192  | A     |
| Diode Forward Voltage            | V <sub>SD</sub>     | Is=20A, V <sub>GS</sub> =0V  | -    | 0.9  | 1.3  | V     |
| Reverse Recovery Time            | Trr                 | V <sub>GS</sub> =0V, I <sub>S</sub> =20A   | -    | 20   | -    | ns    |
| Reverse Recovery Charge          | Qrr                 | dl <sub>s</sub> /dt=100A/us  | -    | 10   | -    | nC    |

NOTES :

- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an  $R_{\theta JC}$ =4.2°C/W.
- 4.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH,  $I_{AS}$ =13A,  $V_{DD}$ =30V,  $V_{GS}$ =10V, Starting  $T_J$ =25°C.
- 6. Guaranteed by design, not subject to production testing.



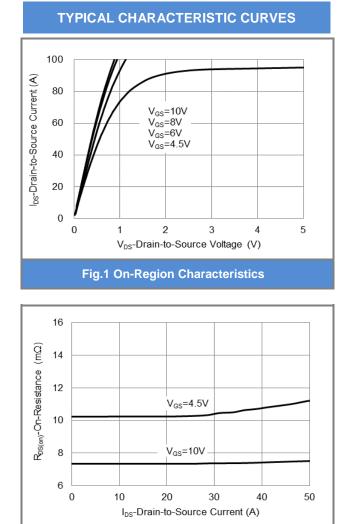
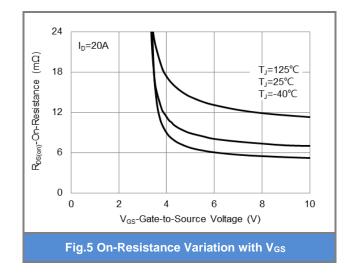
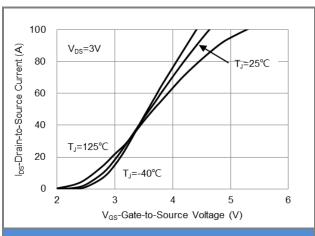


Fig.3 On-Resistance vs. Drain Current





**Fig.2 Transfer Characteristics** 

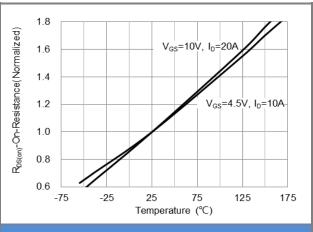


Fig.4 On-Resistance vs. Junction temperature

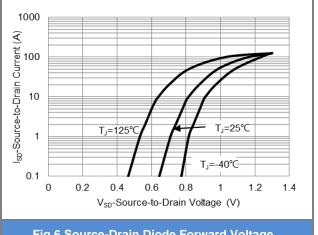


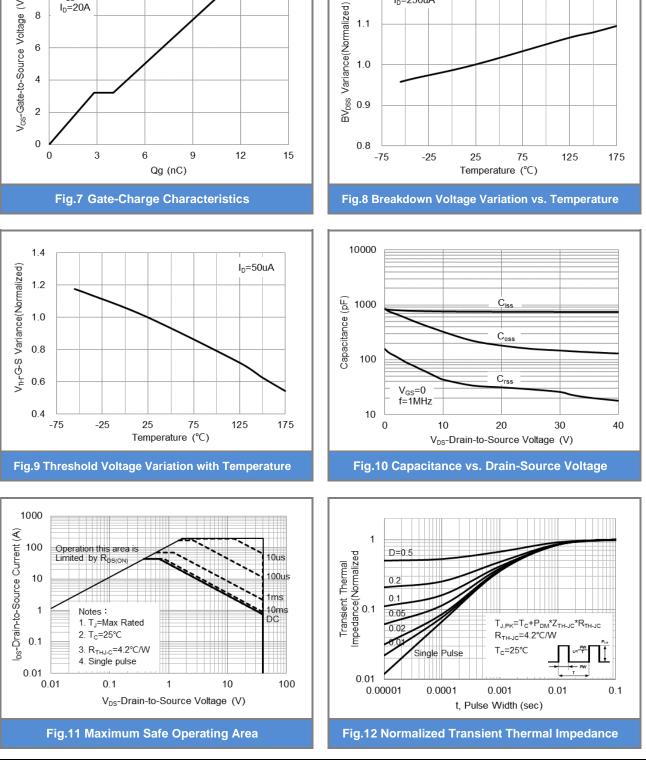
Fig.6 Source-Drain Diode Forward Voltage

January 30,2023

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1.2

1.1

1.0

0.9

I<sub>D</sub>=250uA

**TYPICAL CHARACTERISTIC CURVES** 10 V<sub>DS</sub>=32V V<sub>GS</sub>-Gate-to-Source Voltage (V) I<sub>D</sub>=20A 8 6 4 2

**PJQ5548-AU** 

PAN SEM CONDUCTOR

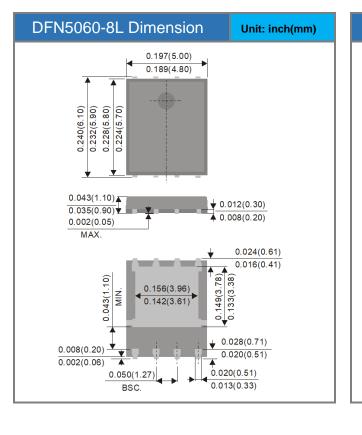


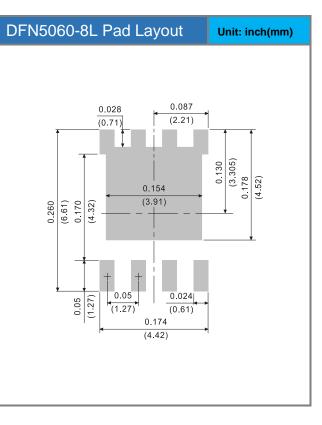


#### Part No. Packing Code Version

| Part No. Packing Code | Package Type | Packing Type      | Marking | Version                        |
|-----------------------|--------------|-------------------|---------|--------------------------------|
| PJQ5548-AU_R2_002A1   | DFN5060-8L   | 3K pcs / 13" reel | Q5548   | Halogen free<br>RoHS compliant |

#### Packaging Information & Mounting Pad Layout







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